

T-1 (3mm) SOLID STATE LAMP



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE **SENSITIVE** DEVICES

Part Number: WP710A10ID14V

High Efficiency Red

Features

- Low power consumption.
- Popular T-1 diameter package.
- General purpose leads.
- Reliable and rugged.
- Long life solid state reliability.
- Available on tape and reel.
- 14V internal resistor.
- RoHS compliant.

Description

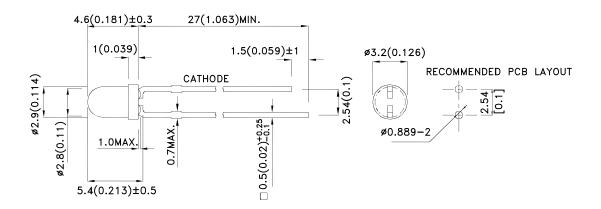
The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

PAGE: 1 OF 6 SPEC NO: DSAL0506 **REV NO: V.4A** DATE: AUG/30/2013 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1101029207





Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] V= 14V		Viewing Angle [1]
		2.	Min.	Тур.	201/2
WP710A10ID14V	High Efficiency Red (GaAsP/GaP)	Red Diffused	10	20	40°
			*5	*10	

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	VF=14V
λD [1]	Dominant Wavelength	High Efficiency Red	617		nm	VF=14V
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	VF=14V
lF	Forward Current	High Efficiency Red	10.5	13.5	mA	VF=14V
lR	Reverse Current	High Efficiency Red		10	uA	VR = 5V

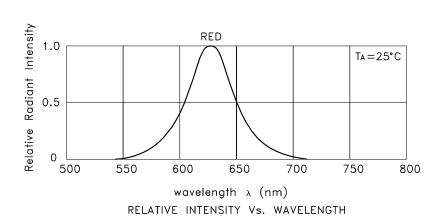
Note:
1.Wavelength: +/-1nm.
2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

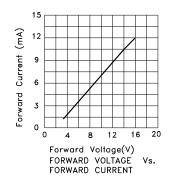
Parameter	High Efficiency Red	Units	
Power dissipation	160	mW	
Forward Voltage	16	V	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +70°C		
Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [1]	260°C For 3 Seconds		
Lead Solder Temperature [2]	260°C For 5 Seconds		

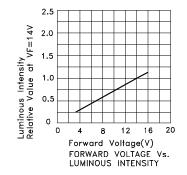
- 2mm below package base.
 5mm below package base.

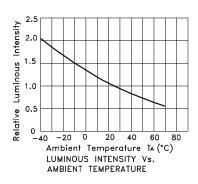
SPEC NO: DSAL0506 **REV NO: V.4A** DATE: AUG/30/2013 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1101029207

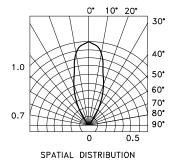


High Efficiency Red WP710A10ID14V

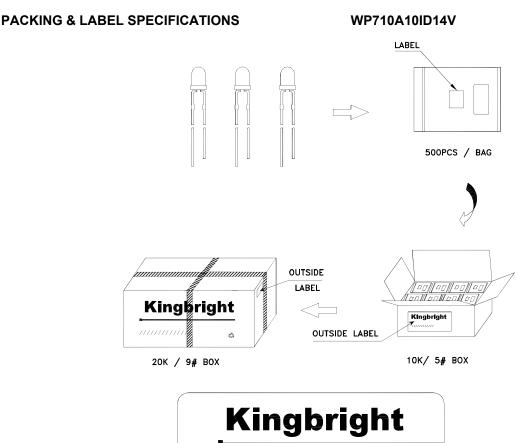








SPEC NO: DSAL0506 REV NO: V.4A DATE: AUG/30/2013 PAGE: 3 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1101029207



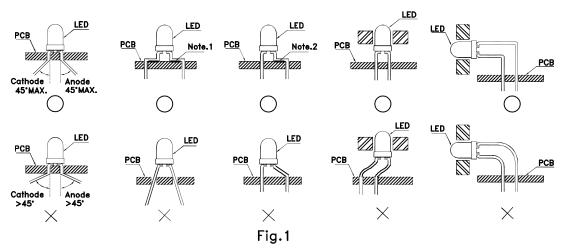
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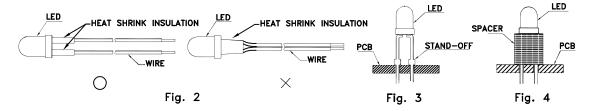
SPEC NO: DSAL0506 REV NO: V.4A DATE: AUG/30/2013 PAGE: 4 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1101029207

PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



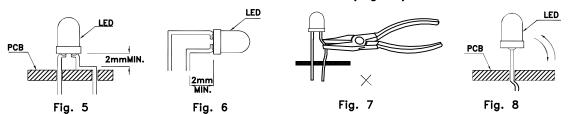
- "() " Correct mounting method "imes" Incorrect mounting method
- 2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig.2)
- 3. Use stand—offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



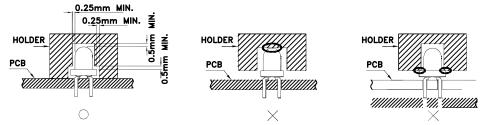
- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

SPEC NO: DSAL0506 APPROVED: WYNEC REV NO: V.4A CHECKED: Allen Liu DATE: AUG/30/2013 DRAWN: Y.Liu PAGE: 5 OF 6 ERP: 1101029207

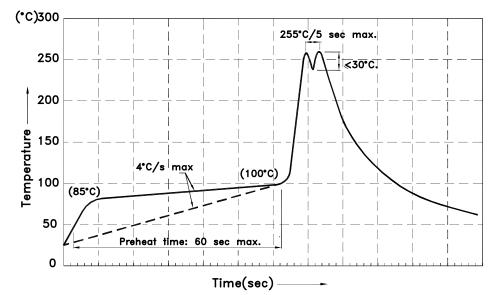
6. Do not bend the leads more than twice. (Fig. 8)



7. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- 8. The tip of the soldering iron should never touch the lens epoxy.
- 9. Through—hole LEDs are incompatible with reflow soldering.
- 10. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 11. Recommended Wave Soldering Profiles:



Notes:

- 1.Recommend pre—heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245°C \sim 255°C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4.Fixtures should not incur stress on the component when mounting and during soldering process. 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.

SPEC NO: DSAL0506 REV NO: V.4A DATE: AUG/30/2013 PAGE: 6 OF 6

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